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### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	HCS12
Core Size	16-Bit
Speed	25MHz
Connectivity	I <sup>2</sup> C, SCI, SPI
Peripherals	PWM, WDT
Number of I/O	59
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.35V ~ 5.25V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-QFP
Supplier Device Package	80-QFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/mc9s12a32cfue">https://www.e-xfl.com/product-detail/nxp-semiconductors/mc9s12a32cfue</a>

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- **Ports**
  - The CAN0 pin functionality (TXCAN0, RXCAN0) is not available on port PJ7, PJ6, PM5, PM4, PM3, PM2, PM1 and PM0, if using a derivative without CAN0 (see **Table 0-1**).
  - The BDLC pin functionality (TXB, RXB) is not available on port PM1 and PM0, if using a derivative without BDLC (see **Table 0-1**).
  - Do not write MODRR1 and MODRR0 Bit of Module Routing Register (PIM\_9DJ64 Block User Guide), if using a derivative without CAN0 (see **Table 0-1**).
- **Pins not available in 80 pin QFP package**
  - **Port H**  
In order to avoid floating nodes the ports should be either configured as outputs by setting the data direction register (DDRH at Base+\$0262) to \$FF, or enabling the pull resistors by writing a \$FF to the pull enable register (PERH at Base+\$0264).
  - **Port J[1:0]**  
Port J pull-up resistors are enabled out of reset on all four pins (7:6 and 1:0). Therefore care must be taken not to disable the pull enables on PJ[1:0] by clearing the bits PERJ1 and PERJ0 at Base+\$026C.
  - **Port K**  
Port K pull-up resistors are enabled out of reset, i.e. Bit 7 = PUKE = 1 in the register PUCR at Base+\$000C. Therefore care must be taken not to clear this bit.
  - **Port M[7:6]**  
PM7:6 must be configured as outputs or their pull resistors must be enabled to avoid floating inputs.
  - **Port P6**  
PP6 must be configured as output or its pull resistor must be enabled to avoid a floating input.
  - **Port S[7:4]**  
PS7:4 must be configured as outputs or their pull resistors must be enabled to avoid floating inputs.
  - **PAD[15:8] (ATD1 channels)**  
Out of reset the ATD1 is disabled preventing current flows in the pins. Do not modify the ATD1 registers!

## Document References

The Device User Guide provides information about the MC9S12DJ64 device made up of standard HCS12 blocks and the HCS12 processor core.

This document is part of the customer documentation. A complete set of device manuals also includes all the individual Block Guides of the implemented modules. In an effort to reduce redundancy all module specific information is located only in the respective Block Guide. If applicable, special implementation details of the module are given in the block description sections of this document.

See **Table 0-2** for names and versions of the referenced documents throughout the Device User Guide.

**Table 1-2 Device Memory Map for MC9S12D32**

Address	Module	Size (Bytes)
\$0000 - \$000F	HCS12 Multiplexed External Bus Interface	16
\$0010 - \$0014	HCS12 Module Mapping Control	5
\$0015 - \$0016	HCS12 Interrupt	2
\$0017 - \$0019	Reserved	3
\$001A - \$001B	Device ID register (PARTID)	2
\$001C - \$001D	HCS12 Module Mapping Control	2
\$001E	HCS12 Multiplexed External Bus Interface	1
\$001F	HCS12 Interrupt	1
\$0020 - \$0027	Reserved	8
\$0028 - \$002F	HCS12 Breakpoint Module	8
\$0030 - \$0031	HCS12 Module Mapping Control	2
\$0032 - \$0033	HCS12 Multiplexed External Bus Interface	2
\$0034 - \$003F	Clock and Reset Generator (PLL, RTI, COP)	12
\$0040 - \$007F	Enhanced Capture Timer 16-bit 8 channels	64
\$0080 - \$009F	Analog to Digital Converter 10-bit 8 channels (ATD0)	32
\$00A0 - \$00C7	Pulse Width Modulator 8-bit 8 channels (PWM)	40
\$00C8 - \$00CF	Serial Communications Interface 0 (SCI0)	8
\$00D0 - \$00D7	Serial Communications Interface 0 (SCI1)	8
\$00D8 - \$00DF	Serial Peripheral Interface (SPI0)	8
\$00E0 - \$00E7	Inter IC Bus	8
\$00E8 - \$00EF	Byte Data Link Controller (BDLC)	8
\$00F0 - \$00FF	Reserved	16
\$0100 - \$010F	Flash Control Register	16
\$0110 - \$011B	EEPROM Control Register	12
\$011C - \$011F	Reserved	4
\$0120 - \$013F	Analog to Digital Converter 10-bit 8 channels (ATD1)	32
\$0140 - \$017F	Freescale Scalable Can (CAN0)	
\$0180 - \$023F	Reserved	192
\$0240 - \$027F	Port Integration Module (PIM)	64
\$0280 - \$03FF	Reserved	384
\$0000 - \$07FF	EEPROM array 1k Array mapped twice in the address space	2048
\$0000 - \$0FFF	RAM array, lower half (\$0000-\$07FF not usable)	4096
\$4000 - \$7FFF	16k Fixed Flash EEPROM array (same as array from \$8000 - \$BFFF when ROMHM=0)	16384
\$8000 - \$FFFF	32K Fixed Flash EEPROM array	32768

64

**\$0010 - \$0014****MMC map 1 of 4 (HCS12 Module Mapping Control)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0012	INITEE	Read:	EE15	EE14	EE13	EE12	EE11	0	0	EEON
		Write:								
\$0013	MISC	Read:	0	0	0	0	EXSTR1	EXSTR0	ROMHM	ROMON
		Write:								
\$0014	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								

**\$0015 - \$0016****INT map 1 of 2 (HCS12 Interrupt)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0015	ITCR	Read:	0	0	0	WRINT	ADR3	ADR2	ADR1	ADR0
		Write:								
\$0016	ITEST	Read:	INTE	INTC	INTA	INT8	INT6	INT4	INT2	INT0
		Write:								

**\$0017 - \$0019****Reserved**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0017 - \$0019	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								

**\$001A - \$001B****Device ID Register (Table 1-4)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$001A	PARTIDH	Read:	ID15	ID14	ID13	ID12	ID11	ID10	ID9	ID8
		Write:								
\$001B	PARTIDL	Read:	ID7	ID6	ID5	ID4	ID3	ID2	ID1	ID0
		Write:								

**\$001C - \$001D****MMC map 3 of 4 (HCS12 Module Mapping Control, Table 1-5)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$001C	MEMSIZ0	Read:	reg_sw0	0	eep_sw1	eep_sw0	0	ram_sw2	ram_sw1	ram_sw0
		Write:								
\$001D	MEMSIZ1	Read:	rom_sw1	rom_sw0	0	0	0	0	pag_sw1	pag_sw0
		Write:								

**\$001E - \$001E****MEBI map 2 of 3 (HCS12 Multiplexed External Bus Interface)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$001E	INTCR	Read:	IRQE	IRQEN	0	0	0	0	0	0
		Write:								

**\$00A0 - \$00C7****PWM (Pulse Width Modulator 8 Bit 8 Channel)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$00C2	PWMDTY6	Read:	Bit 7	6	5	4	3	2	1	Bit 0
		Write:								
\$00C3	PWMDTY7	Read:	Bit 7	6	5	4	3	2	1	Bit 0
		Write:								
\$00C4	PWMSDN	Read:	PWMIF	PWMIE	PWMRSTRT	PWMLVL	0	PWM7IN	PWM7INL	PWM7ENA
		Write:								
\$00C5	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$00C6	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$00C7	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								

**\$00C8 - \$00CF****SCI0 (Asynchronous Serial Interface)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$00C8	SCI0BDH	Read:	0	0	0	SBR12	SBR11	SBR10	SBR9	SBR8
		Write:								
\$00C9	SCI0BDL	Read:	SBR7	SBR6	SBR5	SBR4	SBR3	SBR2	SBR1	SBR0
		Write:								
\$00CA	SCI0CR1	Read:	LOOPS	SCISWAI	RSRC	M	WAKE	ILT	PE	PT
		Write:								
\$00CB	SCI0CR2	Read:	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK
		Write:								
\$00CC	SCI0SR1	Read:	TDRE	TC	RDRF	IDLE	OR	NF	FE	PF
		Write:								
\$00CD	SCI0SR2	Read:	0	0	0	0	0	BRK13	TXDIR	RAF
		Write:								
\$00CE	SCI0DRH	Read:	R8	T8	0	0	0	0	0	0
		Write:								
\$00CF	SCI0DRL	Read:	R7	R6	R5	R4	R3	R2	R1	R0
		Write:	T7	T6	T5	T4	T3	T2	T1	T0

**\$00D0 - \$00D7****SCI1 (Asynchronous Serial Interface)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$00D0	SCI1BDH	Read:	0	0	0	SBR12	SBR11	SBR10	SBR9	SBR8
		Write:								
\$00D1	SCI1BDL	Read:	SBR7	SBR6	SBR5	SBR4	SBR3	SBR2	SBR1	SBR0
		Write:								
\$00D2	SCI1CR1	Read:	LOOPS	SCISWAI	RSRC	M	WAKE	ILT	PE	PT
		Write:								
\$00D3	SCI1CR2	Read:	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK
		Write:								
\$00D4	SCI1SR1	Read:	TDRE	TC	RDRF	IDLE	OR	NF	FE	PF
		Write:								

**\$0120 - \$013F****ATD1 (Analog to Digital Converter 10 Bit 8 Channel)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0139	ATD1DR4L	Read:	Bit7	Bit6	0	0	0	0	0	0
		Write:								
\$013A	ATD1DR5H	Read:	Bit15	14	13	12	11	10	9	Bit8
		Write:								
\$013B	ATD1DR5L	Read:	Bit7	Bit6	0	0	0	0	0	0
		Write:								
\$013C	ATD1DR6H	Read:	Bit15	14	13	12	11	10	9	Bit8
		Write:								
\$013D	ATD1DR6L	Read:	Bit7	Bit6	0	0	0	0	0	0
		Write:								
\$013E	ATD1DR7H	Read:	Bit15	14	13	12	11	10	9	Bit8
		Write:								
\$013F	ATD1DR7L	Read:	Bit7	Bit6	0	0	0	0	0	0
		Write:								

**\$0140 - \$017F****CAN0 (Freescale Scalable CAN - FSCAN)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0140	CAN0CTL0	Read:	RXFRM	RXACT	CSWAI	SYNCH	TIME	WUPE	SLPRQ	INITRQ
		Write:								
\$0141	CAN0CTL1	Read:	CANE	CLKSRC	LOOPB	LISTEN	0	WUPM	SLPAK	INITAK
		Write:								
\$0142	CAN0BTR0	Read:	SJW1	SJW0	BRP5	BRP4	BRP3	BRP2	BRP1	BRP0
		Write:								
\$0143	CAN0BTR1	Read:	SAMP	TSEG22	TSEG21	TSEG20	TSEG13	TSEG12	TSEG11	TSEG10
		Write:								
\$0144	CAN0RFLG	Read:	WUPIF	CSCIF	RSTAT1	RSTAT0	TSTAT1	TSTAT0	OVRIF	RXF
		Write:								
\$0145	CAN0RIER	Read:	WUPIE	CSCIE	RSTATE1	RSTATE0	TSTATE1	TSTATE0	OVRIE	RXFIE
		Write:								
\$0146	CAN0TFLG	Read:	0	0	0	0	0	TXE2	TXE1	TXE0
		Write:								
\$0147	CAN0TIER	Read:	0	0	0	0	0	TXEIE2	TXEIE1	TXEIE0
		Write:								
\$0148	CAN0TARQ	Read:	0	0	0	0	0	ABTRQ2	ABTRQ1	ABTRQ0
		Write:								
\$0149	CAN0TAAK	Read:	0	0	0	0	0	ABTAK2	ABTAK1	ABTAK0
		Write:								
\$014A	CAN0TBSEL	Read:	0	0	0	0	0	TX2	TX1	TX0
		Write:								
\$014B	CAN0IDAC	Read:	0	0	IDAM1	IDAM0	0	IDHIT2	IDHIT1	IDHIT0
		Write:								
\$014C	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$014D	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$014E	CAN0RXERR	Read:	RXERR7	RXERR6	RXERR5	RXERR4	RXERR3	RXERR2	RXERR1	RXERR0
		Write:								



**\$0140 - \$017F****CAN0 (Freescale Scalable CAN - FSCAN)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$014F	CAN0TXERR	Read:	TXERR7	TXERR6	TXERR5	TXERR4	TXERR3	TXERR2	TXERR1	TXERR0
		Write:								
\$0150 - \$0153	CAN0IDAR0 - CAN0IDAR3	Read:	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
		Write:								
\$0154 - \$0157	CAN0IDMR0 - CAN0IDMR3	Read:	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
		Write:								
\$0158 - \$015B	CAN0IDAR4 - CAN0IDAR7	Read:	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
		Write:								
\$015C - \$015F	CAN0IDMR4 - CAN0IDMR7	Read:	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
		Write:								
\$0160 - \$016F	CAN0RXFG	Read:	FOREGROUND RECEIVE BUFFER see <b>Table 1-3</b>							
		Write:								
\$0170 - \$017F	CAN0TXFG	Read:	FOREGROUND TRANSMIT BUFFER see <b>Table 1-3</b>							
		Write:								

**Table 1-3 Detailed MSCAN Foreground Receive and Transmit Buffer Layout**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	Extended ID	Read:	ID28	ID27	ID26	ID25	ID24	ID23	ID22	ID21
\$0160	Standard ID	Read:	ID10	ID9	ID8	ID7	ID6	ID5	ID4	ID3
	CAN0RIDR0	Write:								
	Extended ID	Read:	ID20	ID19	ID18	SRR=1	IDE=1	ID17	ID16	ID15
\$0161	Standard ID	Read:	ID2	ID1	ID0	RTR	IDE=0			
	CAN0RIDR1	Write:								
	Extended ID	Read:	ID14	ID13	ID12	ID11	ID10	ID9	ID8	ID7
\$0162	Standard ID	Read:								
	CAN0RIDR2	Write:								
	Extended ID	Read:	ID6	ID5	ID4	ID3	ID2	ID1	ID0	RTR
\$0163	Standard ID	Read:								
	CAN0RIDR3	Write:								
\$0164 - \$016B	CAN0RDSR0 - CAN0RDSR7	Read:	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
		Write:								
		Read:					DLC3	DLC2	DLC1	DLC0
\$016C	CAN0RDLR	Write:								
\$016D	Reserved	Read:								
		Write:								
		Read:	TSR15	TSR14	TSR13	TSR12	TSR11	TSR10	TSR9	TSR8
\$016E	CAN0RTSRH	Write:								
		Read:	TSR7	TSR6	TSR5	TSR4	TSR3	TSR2	TSR1	TSR0
\$016F	CAN0RTSRL	Write:								
	Extended ID	Read:	ID28	ID27	ID26	ID25	ID24	ID23	ID22	ID21
\$0170	CAN0TIDR0	Write:								
	Standard ID	Read:	ID10	ID9	ID8	ID7	ID6	ID5	ID4	ID3
		Write:								
	Extended ID	Read:	ID20	ID19	ID18	SRR=1	IDE=1	ID17	ID16	ID15
\$0171	CAN0TIDR1	Write:								
	Standard ID	Read:	ID2	ID1	ID0	RTR	IDE=0			
		Write:								

Pin Name Function1	Pin Name Function2	Pin Name Function3	Pin Name Function4	Powered by	Internal Pull Resistor		Description
					CTRL	Reset State	
PJ7	KWJ7	SCL	TXCAN0	VDDX	PERJ/ PPSJ	Up	Port J I/O, Interrupt, SCL of IIC, TX of CAN0
PJ6	KWJ6	SDA	RXCAN0				Port J I/O, Interrupt, SDA of IIC, RX of CAN0
PJ[1:0]	KWJ[1:0]	—	—				Port J I/O, Interrupts
PK7	ECS	ROMCTL	—	VDDX	PUCR/ PUPKE	Up	Port K I/O, Emulation Chip Select, ROM On Enable
PK[5:0]	XADDR[19:14]	—	—		PERM/ PPSM	Disabled	Port K I/O, Extended Addresses
PM7	—	—	—				Port M I/O
PM6	—	—	—				Port M I/O
PM5	TXCAN0	SCK	—				Port M I/O, TX of CAN0, SCK of SPI0
PM4	RXCAN0	MOSI	—				Port M I/O, RX of CAN0, MOSI of SPI0
PM3	TXCAN0	SS0	—				Port M I/O, TX of CAN0, SS of SPI0
PM2	RXCAN0	MISO0	—				Port M I/O, RX of CAN0, MISO of SPI0
PM1	TXCAN0	TXB	—				Port M I/O, TX of CAN0, RX of BDLC
PM0	RXCAN0	RXB	—				Port M I/O, RX of CAN0, RX of BDLC
PP7	KWP7	PWM7	—				PERP/ PPSP
PP6	KWP6	PWM6	—		Port P I/O, Interrupt, PWM Channel 6		
PP5	KWP5	PWM5	—		Port P I/O, Interrupt, PWM Channel 5		
PP4	KWP4	PWM4	—		Port P I/O, Interrupt, PWM Channel 4		
PP3	KWP3	PWM3	—		Port P I/O, Interrupt, PWM Channel 3		
PP2	KWP2	PWM2	—		Port P I/O, Interrupt, PWM Channel 2		
PP1	KWP1	PWM1	—		Port P I/O, Interrupt, PWM Channel 1		
PP0	KWP0	PWM0	—		Port P I/O, Interrupt, PWM Channel 0		
PS7	SS0	—	—		PERS/ PPSS	Up	Port S I/O, SS of SPI0
PS6	SCK0	—	—				Port S I/O, SCK of SPI0
PS5	MOSI0	—	—				Port S I/O, MOSI of SPI0
PS4	MISO0	—	—				Port S I/O, MISO of SPI0
PS3	TXD1	—	—				Port S I/O, TXD of SCI1
PS2	RXD1	—	—				Port S I/O, RXD of SCI1
PS1	TXD0	—	—				Port S I/O, TXD of SCI0
PS0	RXD0	—	—				Port S I/O, RXD of SCI0
PT[7:0]	IOC[7:0]	—	—		PERT/ PPST	Disabled	Port T I/O, Timer channels

## NOTES:

1. Refer to PEAR register description in HCS12 Multiplexed External Bus Interface (MEBI) Block Guide

## 2.3 Detailed Signal Descriptions

### 2.3.1 EXTAL, XTAL — Oscillator Pins

EXTAL and XTAL are the crystal driver and external clock pins. On reset all the device clocks are derived from the EXTAL input frequency. XTAL is the crystal output.

### 2.3.2 RESET — External Reset Pin

An active low bidirectional control signal, it acts as an input to initialize the MCU to a known start-up state, and an output when an internal MCU function causes a reset.

### 2.3.3 TEST — Test Pin

This input only pin is reserved for test.

**NOTE:** The TEST pin must be tied to VSS in all applications.

### 2.3.4 VREGEN — Voltage Regulator Enable Pin

This input only pin enables or disables the on-chip voltage regulator.

### 2.3.5 XFC — PLL Loop Filter Pin

PLL loop filter. Please ask your Freescale representative for the interactive application note to compute PLL loop filter elements. Any current leakage on this pin must be avoided.

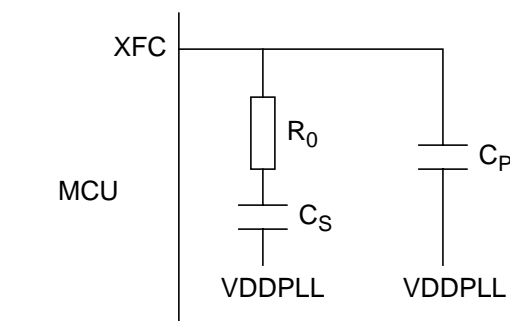


Figure 2-3 PLL Loop Filter Connections

### 2.3.6 BKGD / TAGHI / MODC — Background Debug, Tag High, and Mode Pin

The BKGD/TAGHI/MODC pin is used as a pseudo-open-drain pin for the background debug communication. In MCU expanded modes of operation when instruction tagging is on, an input low on this pin during the falling edge of E-clock tags the high half of the instruction word being read into the

instruction queue. It is used as a MCU operating mode select pin during reset. The state of this pin is latched to the MODC bit at the rising edge of  $\overline{\text{RESET}}$ . This pin has a permanently enabled pull-up device.

### 2.3.7 PAD15 / AN15 / ETRIG1 — Port AD Input Pin of ATD1

PAD15 is a general purpose input pin and analog input AN7 of the analog to digital converter ATD1. It can act as an external trigger input for the ATD1.

### 2.3.8 PAD[14:08] / AN[14:08] — Port AD Input Pins ATD1

PAD14 - PAD08 are general purpose input pins and analog inputs AN[6:0] of the analog to digital converter ATD1.

### 2.3.9 PAD07 / AN07 / ETRIG0 — Port AD Input Pin of ATD0

PAD07 is a general purpose input pin and analog input AN0 of the analog to digital converter ATD0. It can act as an external trigger input for the ATD0.

### 2.3.10 PAD[06:00] / AN[06:00] — Port AD Input Pins of ATD0

PAD06 - PAD00 are general purpose input pins and analog inputs AN[6:0] of the analog to digital converter ATD0.

### 2.3.11 PA[7:0] / ADDR[15:8] / DATA[15:8] — Port A I/O Pins

PA7-PA0 are general purpose input or output pins. In MCU expanded modes of operation, these pins are used for the multiplexed external address and data bus.

### 2.3.12 PB[7:0] / ADDR[7:0] / DATA[7:0] — Port B I/O Pins

PB7-PB0 are general purpose input or output pins. In MCU expanded modes of operation, these pins are used for the multiplexed external address and data bus.

### 2.3.13 PE7 / NOACC / $\overline{\text{XCLKS}}$ — Port E I/O Pin 7

PE7 is a general purpose input or output pin. During MCU expanded modes of operation, the NOACC signal, when enabled, is used to indicate that the current bus cycle is an unused or “free” cycle. This signal will assert when the CPU is not using the bus.

The  $\overline{\text{XCLKS}}$  is an input signal which controls whether a crystal in combination with the internal Colpitts (low power) oscillator is used or whether Pierce oscillator/external clock circuitry is used. The state of this pin is latched at the rising edge of  $\overline{\text{RESET}}$ . If the input is a logic low the EXTAL pin is configured for an external clock drive or a Pierce Oscillator. If input is a logic high a Colpitts oscillator circuit is configured on EXTAL and XTAL. Since this pin is an input with a pull-up device during reset, if the pin is left floating, the default configuration is a Colpitts oscillator circuit on EXTAL and XTAL.

**Table 4-2 Clock Selection Based on PE7**

PE7 = XCLKS	Description
0	Pierce Oscillator/external clock selected

**Table 4-3 Voltage Regulator VREGEN**

VREGEN	Description
1	Internal Voltage Regulator enabled
0	Internal Voltage Regulator disabled, VDD1,2 and VDDPLL must be supplied externally with 2.5V

## 4.3 Security

The device will make available a security feature preventing the unauthorized read and write of the memory contents. This feature allows:

- Protection of the contents of FLASH,
- Protection of the contents of EEPROM,
- Operation in single-chip mode,
- Operation from external memory with internal FLASH and EEPROM disabled.

The user must be reminded that part of the security must lie with the user's code. An extreme example would be user's code that dumps the contents of the internal program. This code would defeat the purpose of security. At the same time the user may also wish to put a back door in the user's program. An example of this is the user downloads a key through the SCI which allows access to a programming routine that updates parameters stored in EEPROM.

### 4.3.1 Securing the Microcontroller

Once the user has programmed the FLASH and EEPROM (if desired), the part can be secured by programming the security bits located in the FLASH module. These non-volatile bits will keep the part secured through resetting the part and through powering down the part.

The security byte resides in a portion of the Flash array.

Check the Flash Block User Guide for more details on the security configuration.

### 4.3.2 Operation of the Secured Microcontroller

#### 4.3.2.1 Normal Single Chip Mode

This will be the most common usage of the secured part. Everything will appear the same as if the part was not secured with the exception of BDM operation. The BDM operation will be blocked.



Figure 22-1 Recommended PCB Layout 112LQFP Colpitts Oscillator

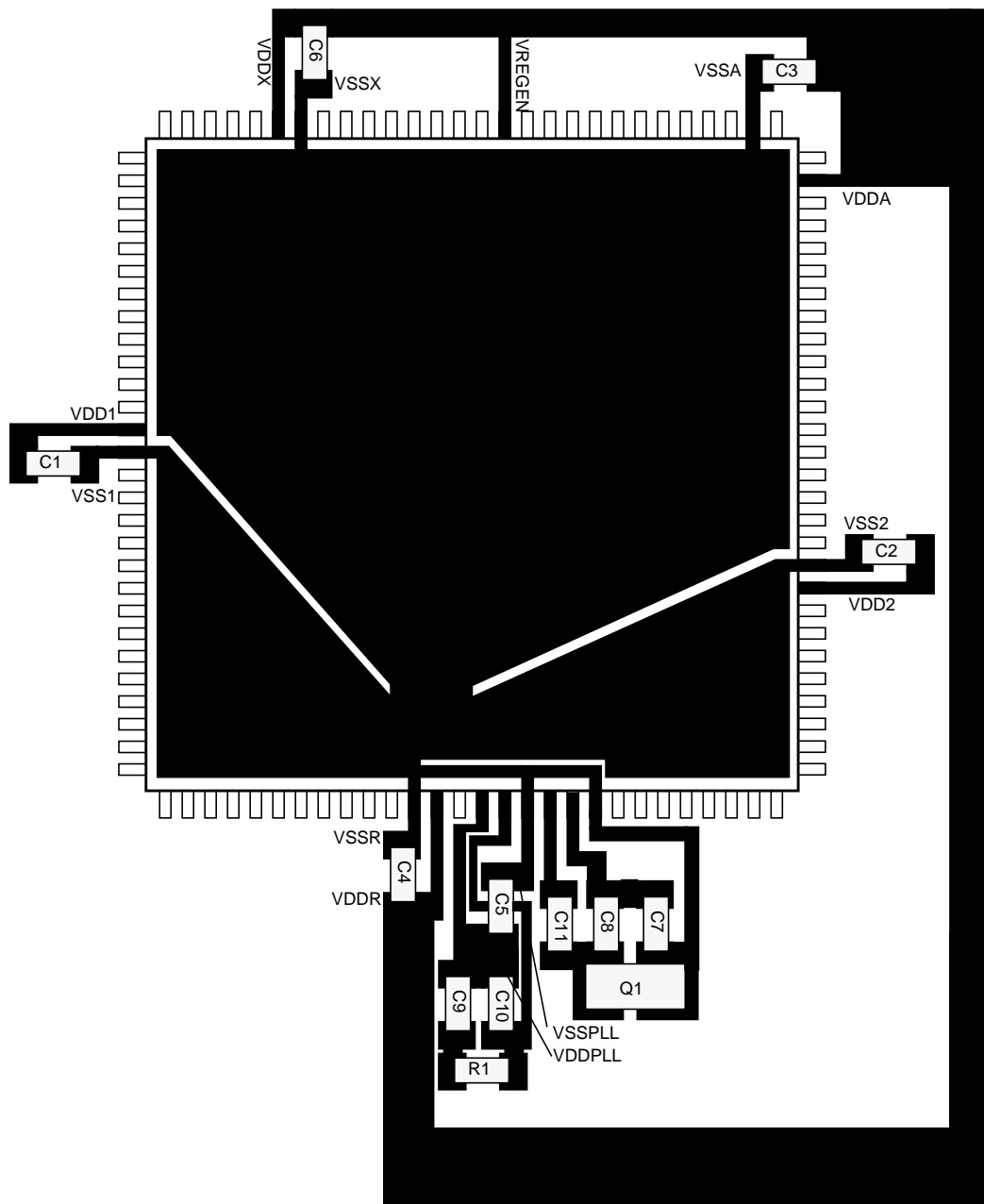
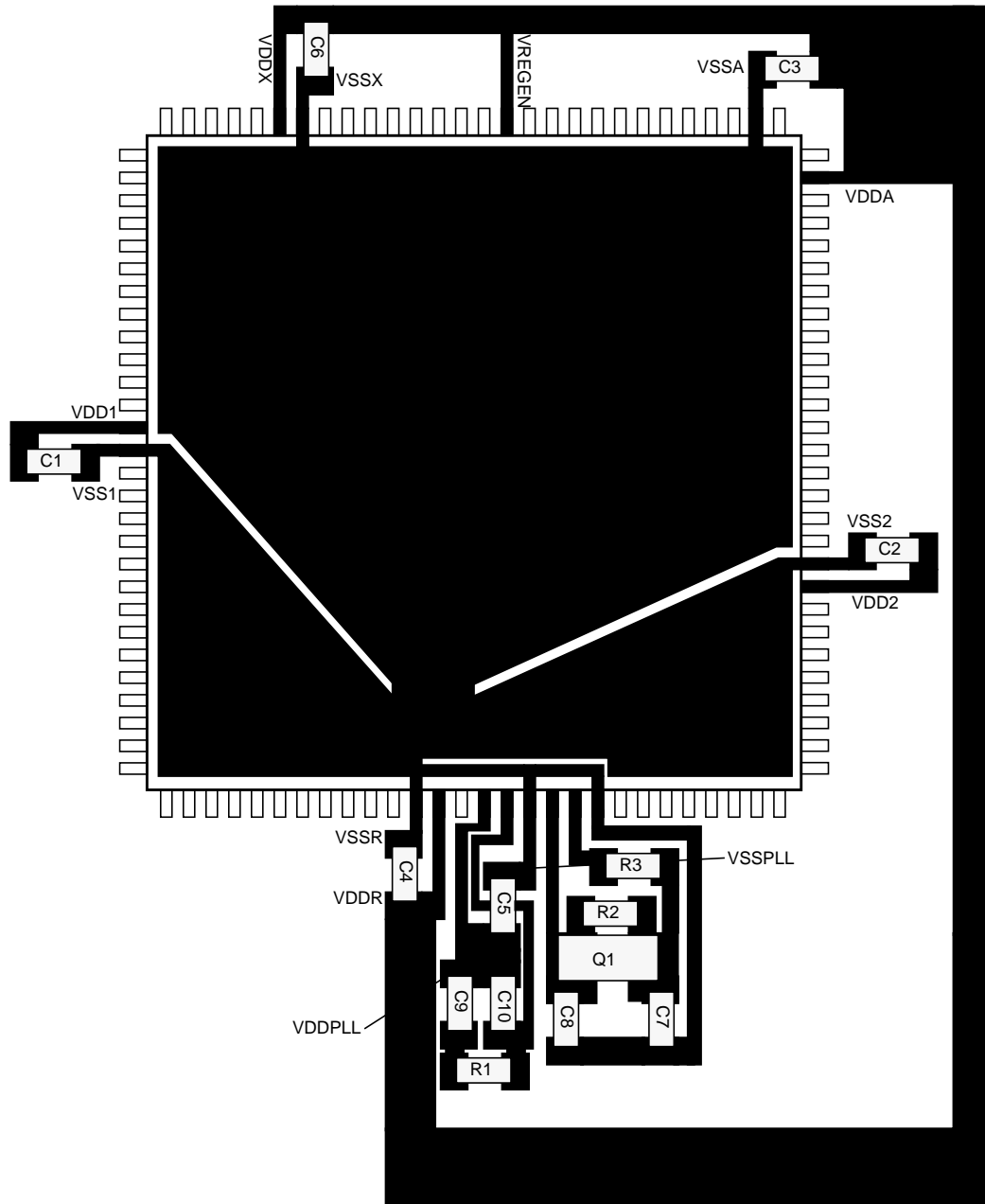


Figure 22-3 Recommended PCB Layout for 112LQFP Pierce Oscillator





## A.2 ATD Characteristics

This section describes the characteristics of the analog to digital converter.

### A.2.1 ATD Operating Characteristics

The **Table A-8** shows conditions under which the ATD operates.

The following constraints exist to obtain full-scale, full range results:

$V_{SSA} \leq V_{RL} \leq V_{IN} \leq V_{RH} \leq V_{DDA}$ . This constraint exists since the sample buffer amplifier can not drive beyond the power supply levels that it ties to. If the input level goes outside of this range it will effectively be clipped.

**Table A-8 ATD Operating Characteristics**

Conditions are shown in <b>Table A-4</b> unless otherwise noted							
Num	C	Rating	Symbol	Min	Typ	Max	Unit
1	D	Reference Potential Low High	$V_{RL}$ $V_{RH}$	$V_{SSA}$ $V_{DDA}/2$		$V_{DDA}/2$ $V_{DDA}$	V V
2	C	Differential Reference Voltage <sup>1</sup>	$V_{RH}-V_{RL}$	4.50	5.00	5.25	V
3	D	ATD Clock Frequency	$f_{ATDCLK}$	0.5		2.0	MHz
4	D	ATD 10-Bit Conversion Period Clock Cycles <sup>2</sup> Conv, Time at 2.0MHz ATD Clock $f_{ATDCLK}$	$N_{CONV10}$ $T_{CONV10}$	14 7		28 14	Cycles $\mu s$
5	D	ATD 8-Bit Conversion Period Clock Cycles <sup>2</sup> Conv, Time at 2.0MHz ATD Clock $f_{ATDCLK}$	$N_{CONV8}$ $T_{CONV8}$	12 6		26 13	Cycles $\mu s$
6	D	Recovery Time ( $V_{DDA}=5.0$ Volts)	$t_{REC}$			20	$\mu s$
7	P	Reference Supply current 2 ATD blocks on	$I_{REF}$			0.750	mA
8	P	Reference Supply current 1 ATD block on	$I_{REF}$			0.375	mA

NOTES:

1. Full accuracy is not guaranteed when differential voltage is less than 4.50V
2. The minimum time assumes a final sample period of 2 ATD clocks cycles while the maximum time assumes a final sample period of 16 ATD clocks.

### A.2.2 Factors influencing accuracy

Three factors - source resistance, source capacitance and current injection - have an influence on the accuracy of the ATD.

#### A.2.2.1 Source Resistance:

Due to the input pin leakage current as specified in **Table A-6** in conjunction with the source resistance there will be a voltage drop from the signal source to the ATD input. The maximum source resistance  $R_S$



## A.4 Voltage Regulator

The on-chip voltage regulator is intended to supply the internal logic and oscillator circuits. No external DC load is allowed.

**Table A-13 Voltage Regulator Recommended Load Capacitances**

Rating	Symbol	Min	Typ	Max	Unit
Load Capacitance on VDD1, 2	$C_{LVDD}$		220		nF
Load Capacitance on VDDPLL	$C_{LVDDfcPLL}$		220		nF

The phase detector relationship is given by:

$$K_{\Phi} = -|i_{ch}| \cdot K_V = 316.7\text{Hz}/\Omega$$

$i_{ch}$  is the current in tracking mode.

The loop bandwidth  $f_C$  should be chosen to fulfill the Gardner's stability criteria by at least a factor of 10, typical values are 50.  $\zeta = 0.9$  ensures a good transient response.

$$f_C < \frac{2 \cdot \zeta \cdot f_{ref}}{\pi \cdot (\zeta + \sqrt{1 + \zeta^2})} \cdot \frac{1}{10} \rightarrow f_C < \frac{f_{ref}}{4 \cdot 10}; (\zeta = 0.9)$$

$$f_C < 25\text{kHz}$$

And finally the frequency relationship is defined as

$$n = \frac{f_{VCO}}{f_{ref}} = 2 \cdot (\text{synr} + 1) = 50$$

With the above values the resistance can be calculated. The example is shown for a loop bandwidth  $f_C=10\text{kHz}$ :

$$R = \frac{2 \cdot \pi \cdot n \cdot f_C}{K_{\Phi}} = 2 \cdot \pi \cdot 50 \cdot 10\text{kHz} / (316.7\text{Hz}/\Omega) = 9.9\text{k}\Omega \approx 10\text{k}\Omega$$

The capacitance  $C_s$  can now be calculated as:

$$C_s = \frac{2 \cdot \zeta^2}{\pi \cdot f_C \cdot R} \approx \frac{0.516}{f_C \cdot R}; (\zeta = 0.9) = 5.19\text{nF} \approx 4.7\text{nF}$$

The capacitance  $C_p$  should be chosen in the range of:

$$C_s/20 \leq C_p \leq C_s/10 \quad C_p = 470\text{pF}$$

### A.5.3.2 Jitter Information

The basic functionality of the PLL is shown in **Figure A-2**. With each transition of the clock  $f_{cmp}$ , the deviation from the reference clock  $f_{ref}$  is measured and input voltage to the VCO is adjusted accordingly. The adjustment is done continuously with no abrupt changes in the clock output frequency. Noise, voltage, temperature and other factors cause slight variations in the control loop resulting in a clock jitter. This jitter affects the real minimum and maximum clock periods as illustrated in **Figure A-3**.

**Table A-19 SPI Slave Mode Timing Characteristics**

Conditions are shown in <b>Table A-4</b> unless otherwise noted, CLOAD = 200pF on all outputs							
Num	C	Rating	Symbol	Min	Typ	Max	Unit
1	P	Operating Frequency	$f_{op}$	DC		1/6	$f_{bus}$
1	P	SCK Period $t_{sck} = 1./f_{op}$	$t_{sck}$	4		2048	$t_{bus}$
2	D	Enable Lead Time	$t_{lead}$	1			$t_{cyc}$
3	D	Enable Lag Time	$t_{lag}$	1			$t_{cyc}$
4	D	Clock (SCK) High or Low Time	$t_{wsck}$	$t_{cyc} - 30$			ns
5	D	Data Setup Time (Inputs)	$t_{su}$	25			ns
6	D	Data Hold Time (Inputs)	$t_{hi}$	25			ns
7	D	Slave Access Time	$t_a$			1	$t_{cyc}$
8	D	Slave MISO Disable Time	$t_{dis}$			1	$t_{cyc}$
9	D	Data Valid (after SCK Edge)	$t_v$			25	ns
10	D	Data Hold Time (Outputs)	$t_{ho}$	0			ns
11	D	Rise Time Inputs and Outputs	$t_r$			25	ns
12	D	Fall Time Inputs and Outputs	$t_f$			25	ns